

### POWER MANAGEMENT

#### Features

- Input voltage range — 1.7V to 5.5V
- 3A continuous output current
- Ultra-Low  $R_{dson}$  —  $9m\Omega$
- Constant  $R_{dson}$  over wide  $V_{IN}$  range
- Device Options
  - SC33001A — Slow turn on slew and with automatic output discharge
  - SC33001AH — Slow turn on slew with no output discharge circuit
- Typical current limit 6A
- Minimum current limit 3A
- Typical foldback current limit 2A
- Over temperature protection
- Low shutdown current
- Low quiescent current
- Package: CSP — 0.9mm x 1.4mm , 0.5mm Pitch

#### Applications

- Battery powered equipment
- Smart Phones/Tablet PCs
- Consumer electronics
- STB/Audio/Video
- Industrial/Network equipment
- Other Portable Devices

#### Description

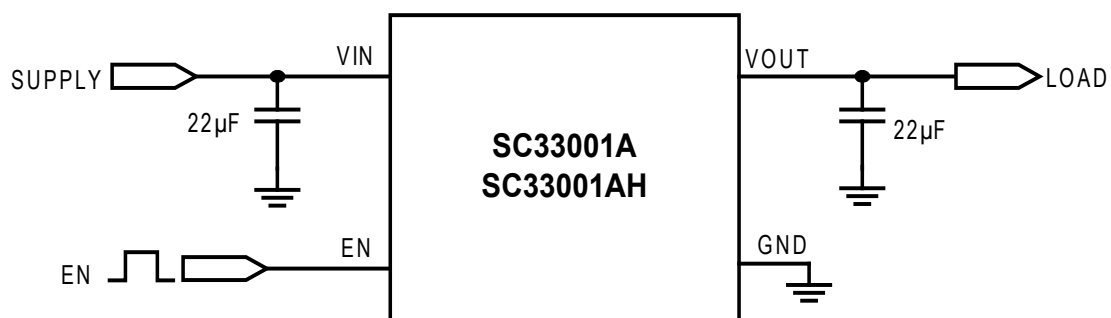
The SC33001A/AH are a family of an ultra-low  $R_{dson}$  load switch optimized for use in battery powered applications. This family of devices support up to 3A continuous output current. Sophisticated integrated circuitry maximizes  $V_{gs}$  of the power NMOS to minimize  $R_{dson}$  resistance over a wide range of operating conditions.

The device provides a controlled soft-start to limit inrush current. SC33001A features an automatic discharge circuit which discharges the output when the SC33001A is disabled. SC33001AH does not include the automatic output discharge circuitry.

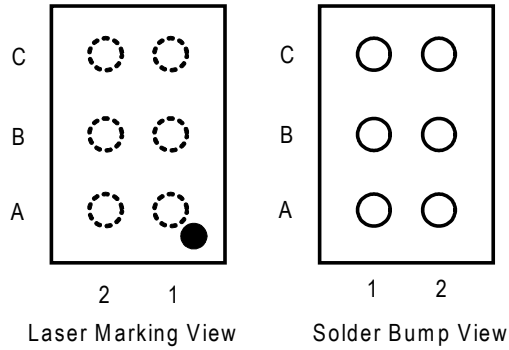
SC33001A/AH family has integrated current limit and over temperature to prevent the device from failure when down stream circuitry is at low impedance fault conditions.

The SC33001A/AH are offered in an ultra small 6-bump 0.9mm x 1.4mm Chip Scale Package (CSP) which enables very small board area implementations. The SC33001A/SC33001AH has an operating temperature range of  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ .

### Typical Application Circuit



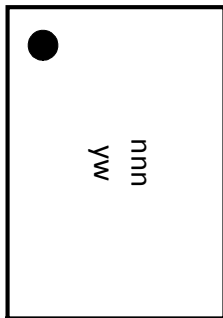
## Pin Configuration



## Terminals Assignments

|   | 1    | 2   |
|---|------|-----|
| C | GND  | EN  |
| B | VOUT | VIN |
| A | VOUT | VIN |

## Marking Information



- nnn = Part No. Code — SC33001A: KS1
- nnn = Part No. Code — SC33001AH: KSH
- yw = Datecode

## Ordering Information

| Device                           | Package                   |
|----------------------------------|---------------------------|
| SC33001ACSTRT <sup>(1)(2)</sup>  | CSP 0.9mm × 1.4mm, 6-Bump |
| SC33001AHCSTRT <sup>(1)(2)</sup> | CSP 0.9mm × 1.4mm, 6-Bump |
| SC33001A-EVB                     | Evaluation Board          |
| SC33001AH-EVB                    | Evaluation Board          |

### Notes:

- (1) Available in tape and reel only. A reel contains 3,000 devices.
- (2) Lead-free package only. Device is WEEE and RoHS compliant.

### Absolute Maximum Ratings

|   |                                 |
|---|---------------------------------|
| V <sub>IN</sub> (V) .....                     | -0.3 to +6.0                    |
| EN (V) .....                                  | -0.3 to +6.0                    |
| V <sub>OUT</sub> (V) .....                    | -0.3 to (V <sub>IN</sub> + 0.3) |
| ESD HBM Protection Level <sup>(1)</sup> ..... | Class 1C                        |

### Recommended Operating Conditions

|                                      |                            |
|--------------------------------------|----------------------------|
| Ambient Temperature Range (°C) ..... | -40 ≤ T <sub>A</sub> ≤ +85 |
| V <sub>IN</sub> (V) .....            | 1.7 to 5.5                 |
| V <sub>OUT</sub> (V) .....           | 0 to V <sub>IN</sub>       |
| Maximum Output Current (A) .....     | 3                          |

### Thermal Information

|   |             |
|---|-------------|
| Thermal Resistance, Junction to Ambient <sup>(2)</sup> (°C/W) ... | 125         |
| Maximum Junction Temperature (°C) .....                           | +150        |
| Storage Temperature Range (°C) .....                              | -65 to +150 |
| Peak IR Reflow Temperature (10s to 30s) (°C) .....                | +260        |

Exceeding the above specifications may result in permanent damage to the device or device malfunction. Operation outside of the parameters specified in the Electrical Characteristics section is not recommended.

NOTES:

- (1) Tested according to JEDEC standard JESD22-A114-B.
- (2) Calculated from package in still air, mounted to 3 x 4.5 (in), 4 layer FR4 PCB with thermal vias under the exposed pad per JESD51 standards.

### Electrical Characteristics

Unless otherwise noted V<sub>IN</sub> = 5.5V, C<sub>IN</sub> = 2.2μF, C<sub>OUT</sub> = 22μF, V<sub>EN</sub> ≥ V<sub>IH</sub>, T<sub>A</sub> = -40°C to +85°C. Typical values are at T<sub>A</sub> = 25°C.

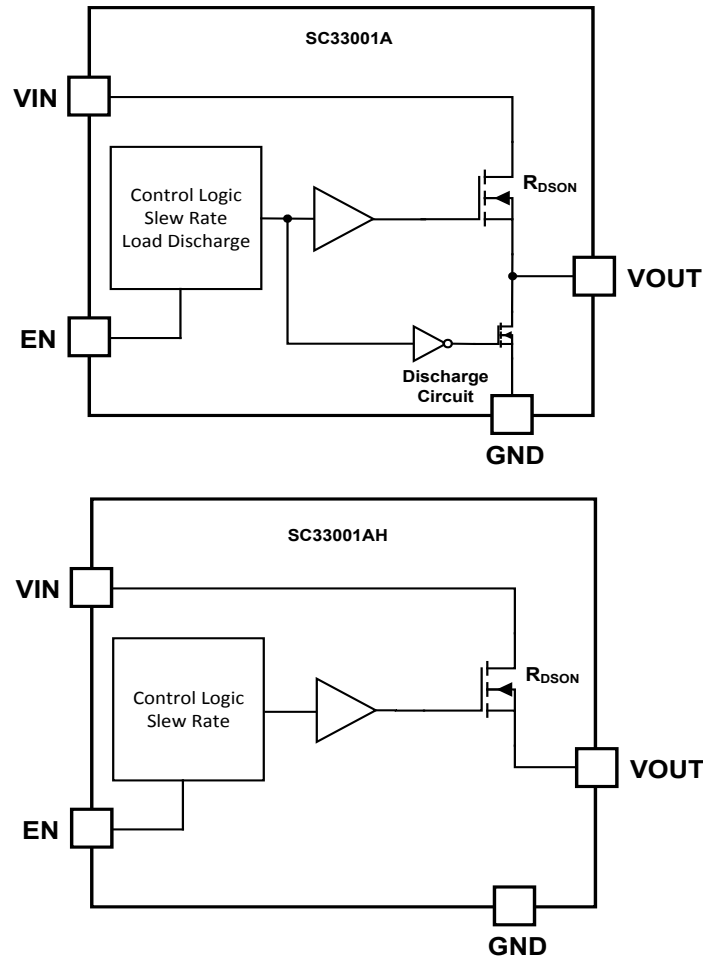
| Parameter                           | Symbol            | Conditions   | Min | Typ  | Max | Units |
|-------------------------------------|-------------------|--|-----|------|-----|-------|
| ON-state Resistance                 | R <sub>DSON</sub> | I <sub>OUT</sub> = 500mA, V <sub>IN</sub> = 1.7V   |     | 9    |     | mΩ    |
|                                     |                   | I <sub>OUT</sub> = 500mA, V <sub>IN</sub> = 2.5V   |     | 9    |     |       |
|                                     |                   | I <sub>OUT</sub> = 500mA, V <sub>IN</sub> = 3.3V   |     | 9    |     |       |
|                                     |                   | I <sub>OUT</sub> = 500mA, V <sub>IN</sub> = 3.6V   |     | 9    |     |       |
|                                     |                   | I <sub>OUT</sub> = 500mA, V <sub>IN</sub> = 5.5V   |     | 9    |     |       |
|                                     |                   | I <sub>OUT</sub> = 500mA, 1.7V ≤ V <sub>IN</sub> ≤ 5.5V                                    |     |      | 13  |       |
| Shutdown Current                    | I <sub>SD</sub>   | EN = 0V, 1.7V ≤ V <sub>IN</sub> ≤ 5.5V   |     |      | 3.5 | μA    |
| Quiescent Current                   | I <sub>Q</sub>    | 1.7V ≤ V <sub>IN</sub> ≤ 5.5V  |     |      | 270 | μA    |
|                                     |                   | V <sub>IN</sub> = 3.6V   |     | 150  |     |       |
| Pull Down Resistance <sup>(1)</sup> | R <sub>PD</sub>   | SC33001A   |     | 1.1  |     | kΩ    |
| Turn On Time for SC33001A/AH        | T <sub>ON</sub>   | From rising edge of EN to 50% of V <sub>OUT</sub> ,<br>V <sub>IN</sub> = 1.7V, Load = 10 Ω |     | 1300 |     | μs    |
|                                     |                   | From rising edge of EN to 50% of V <sub>OUT</sub> ,<br>V <sub>IN</sub> = 3.6V, Load = 10 Ω |     | 1300 |     |       |
|                                     |                   | From rising edge of EN to 50% of V <sub>OUT</sub> ,<br>V <sub>IN</sub> = 5.5V, Load = 10 Ω |     | 1700 |     |       |

**Electrical Characteristics (continued)**

| Parameter   | Symbol              | Conditions  | Min | Typ  | Max  | Units       |
|---|---------------------|---|-----|------|------|-------------|
| Rise Time for SC33001A/AH                           | $T_R$               | From 10% to 90% of VOUT,<br>$V_{IN} = 1.7V$ , Load = 10 $\Omega$                |     | 630  |      | $\mu s$     |
|   |                     | From 10% to 90% of VOUT,<br>$V_{IN} = 3.6V$ , Load = 10 $\Omega$                |     | 950  |      |             |
|   |                     | From 10% to 90% of VOUT,<br>$V_{IN} = 5.5V$ , Load = 10 $\Omega$                |     | 1200 |      |             |
| Turn Off Time for SC33001A/AH                       | $T_{OFF}$           | From falling edge of EN to 50% of VOUT,<br>$V_{IN} = 1.7V$ , Load = 10 $\Omega$ |     | 75   |      | $\mu s$     |
|   |                     | From falling edge of EN to 50% of VOUT,<br>$V_{IN} = 3.6V$ , Load = 10 $\Omega$ |     | 75   |      |             |
|   |                     | From falling edge of EN to 50% of VOUT,<br>$V_{IN} = 5.5V$ , Load = 10 $\Omega$ |     | 75   |      |             |
| Fall Time for SC33001A/AH                           | $T_F$               | From 90% to 10% of VOUT,<br>$V_{IN} = 1.7V$ , Load = 10 $\Omega$                |     | 350  |      | $\mu s$     |
|   |                     | From 90% to 10% of VOUT,<br>$V_{IN} = 3.6V$ , Load = 10 $\Omega$                |     | 350  |      |             |
|   |                     | From 90% to 10% of VOUT,<br>$V_{IN} = 5.5V$ , Load = 10 $\Omega$                |     | 350  |      |             |
| <b>EN Digital Input</b>                             |                     |   |     |      |      |             |
| EN Input High Threshold                             | $V_{IH}$            |   |     | 0.9  | 1.05 | V           |
| EN Input Low Threshold                              | $V_{IL}$            |   | 0.4 |      |      | V           |
| Logic Input High Current                            | $I_{IH}$            |   |     |      | 0.1  | $\mu A$     |
| Logic Input Low Current                             | $I_{IL}$            |   |     |      | 0.1  | $\mu A$     |
| <b>Protection</b>                                   |                     |   |     |      |      |             |
| Current Limit Threshold                             | $I_{LIM}$           | Peak Current<br>1.7V $\leq$ Vin $\leq$ 5.5V, Rload=10m $\Omega$ , EN Rising     | 3   | 6    | 9    | A           |
| Foldback Current Limit                              | $I_{LIM\_FOLD}$     |   |     | 2    |      | A           |
| Over Current Response Time                          | $T_{ILIM}$          |   |     | 100  |      | $\mu s$     |
| Thermal Shutdown Threshold                          | $T_{th}$            |   |     | 160  |      | $^{\circ}C$ |
| Thermal Shutdown Hysteresis                         | $T_{hys}$           |   |     | 38   |      | $^{\circ}C$ |
| Voltage Threshold Transition from ILIM_FOLD to ILIM | $V_{Rth\_ILIM\_TR}$ |   |     | 90%  |      | VIN         |

Notes: (1) SC33001A: see Output Pull Down operation in Applications Information section.

## Block Diagram

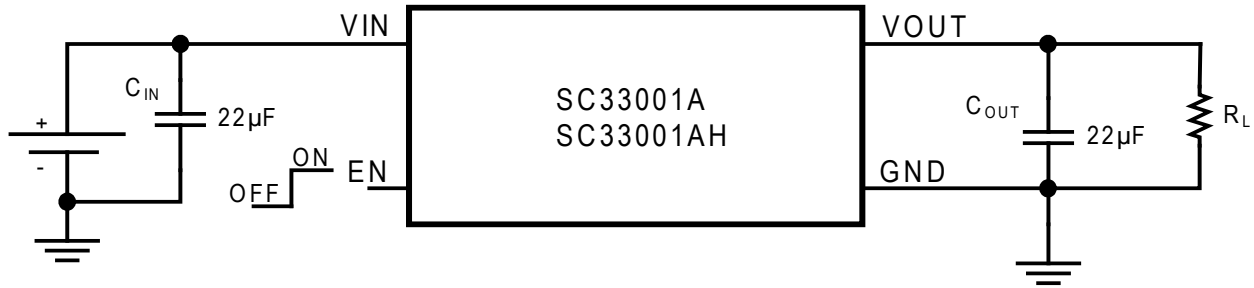
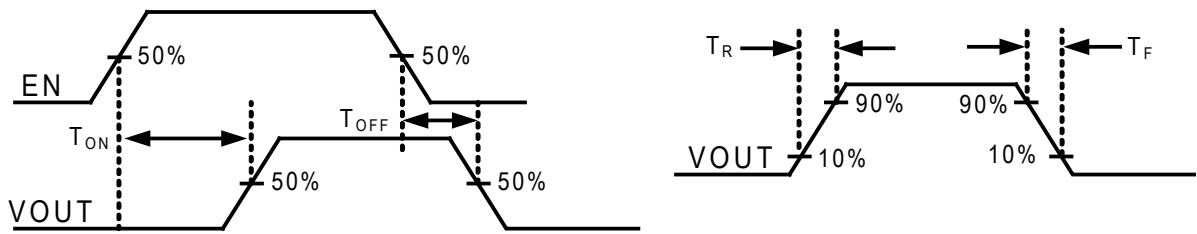


## Pin Descriptions

| Pin #  | Pin Name | Pin Function  |
|--------|----------|---|
| A1, B1 | VOUT     | Switch output - connect a bypass capacitor of at least 0.1uF to the GND pin. Minimize the PCB layout path inductance for this bypass capacitor between the VOUT pins and the GND pin. |
| A2, B2 | VIN      | Switch input - connect a bypass capacitor of at least 1uF to the GND pin. Minimize the PCB layout path inductance for this bypass capacitor between the VIN pins and the GND pin.     |
| C1     | GND      | Ground reference.   |
| C2     | EN       | Enable/disable.   |

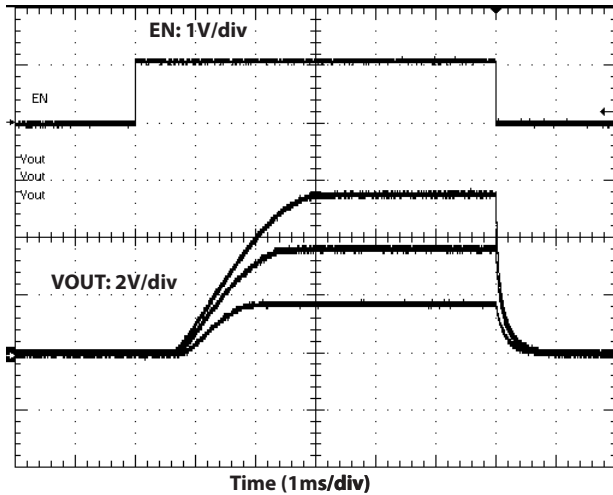
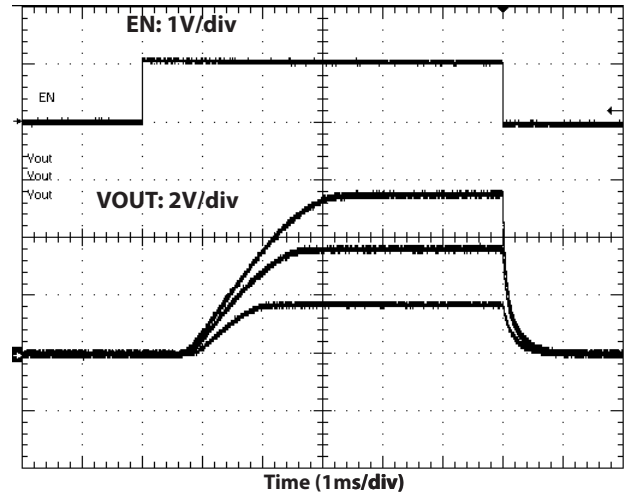
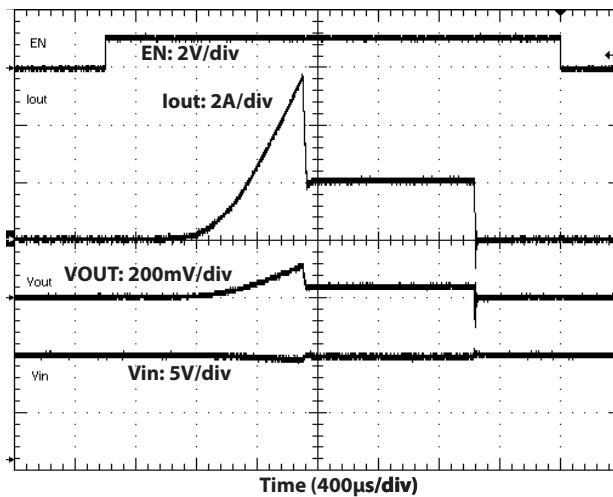
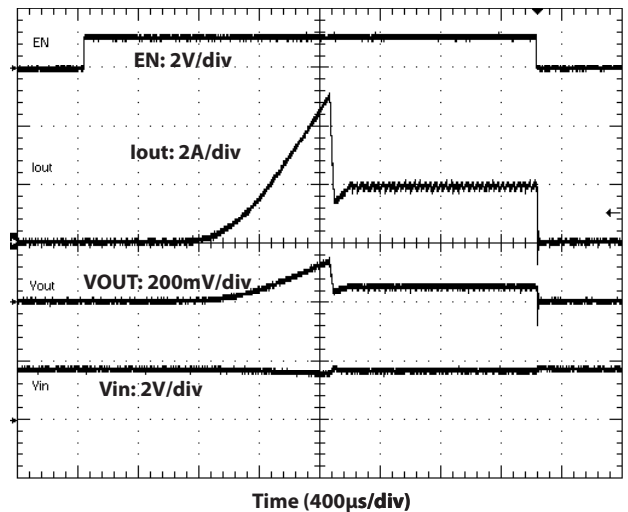
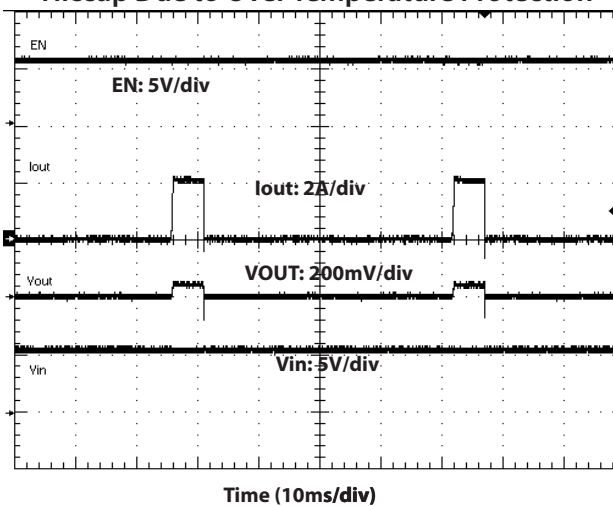
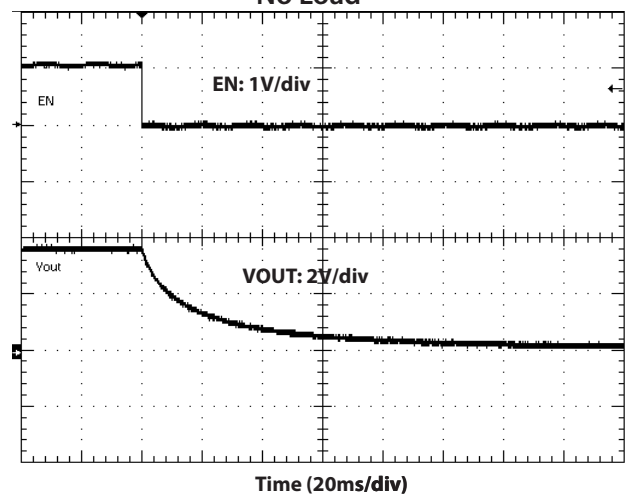
## Key Components

| Component        | Value             | Manufacture | Part Number       | Website        |
|------------------|-------------------|-------------|-------------------|----------------|
| Input Capacitor  | 22uF/0603/X5R/10V | Murata      | GRM188R61A226ME15 | www.murata.com |
| Output Capacitor | 22uF/0603/X5R/10V | Murata      | GRM188R61A226ME15 | www.murata.com |

**Parameter Measurement Information**

**TEST CIRCUIT**

**T<sub>ON</sub>, T<sub>OFF</sub>, T<sub>R</sub>, T<sub>F</sub> WAVEFORMS**

**Typical Characteristics:**

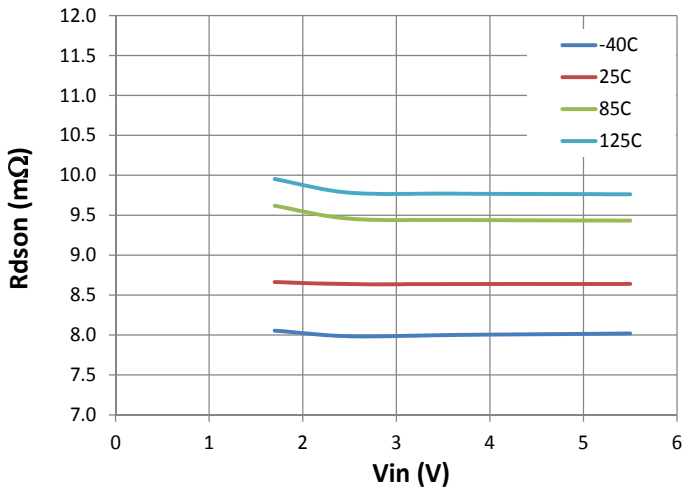
Characteristics in this section are based upon using SC33001A,AH evaluation board ( $C_{IN} = 22\mu F + 1\mu F$ ,  $C_{OUT} = 22\mu F + 1\mu F$ ).

**SC33001AH, 10 Ohm Load,  $V_{in}=1.7V, 3.6V, 5.5V$** 

**SC33001A, 10 Ohm Load,  $V_{in}=1.7V, 3.6V, 5.5V$** 

**Enable to Short Circuit,  $V_{in}=3.6V$ , Device off due to OTP**

**Enable to Short Circuit,  $V_{in}=1.7V$** 

**EN=High,  $V_{in}=5.5V$ , Short Circuit Operation Hiccup Due to Over Temperature Protection**

**Vout Disabled Operation: SC33001A,  $V_{in}=3.6V$  No Load**


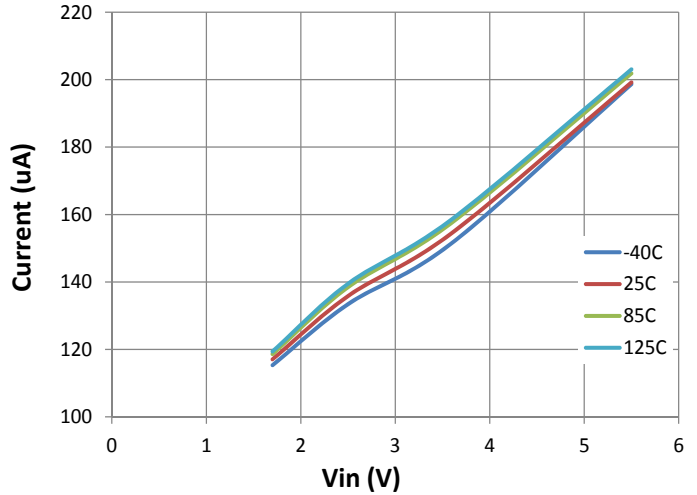
### Typical Characteristics:

Characteristics in this section are based upon using SC33001A, AH evaluation board ( $C_{IN} = 22\mu F + 1\mu F$ ,  $C_{OUT} = 22\mu F + 1\mu F$ ).

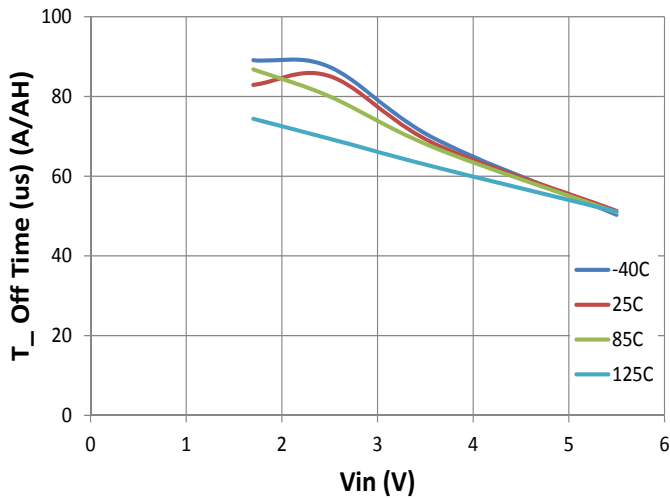
**On Resistance (EN=VIN)**



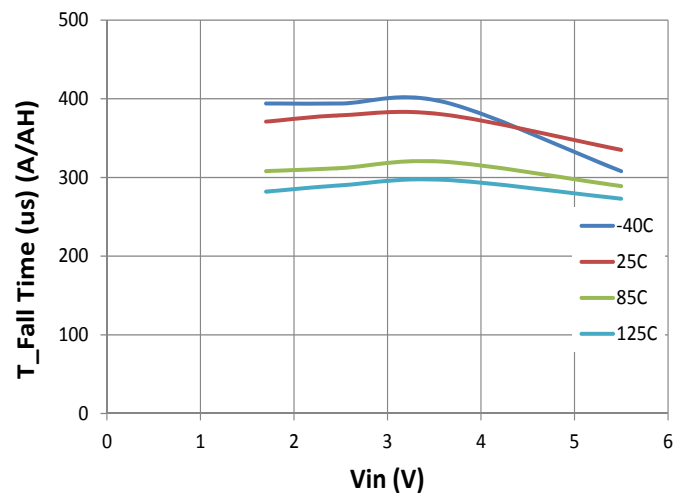
**Quicent Current (0A Load)**



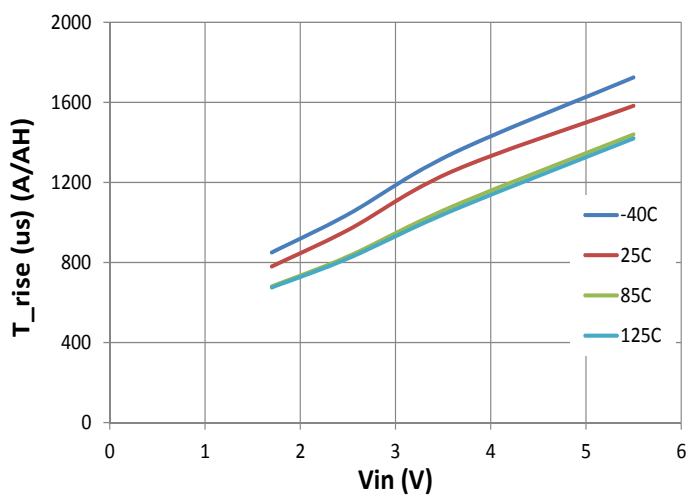
**Turn-Off Time at 10 Ohm Load**



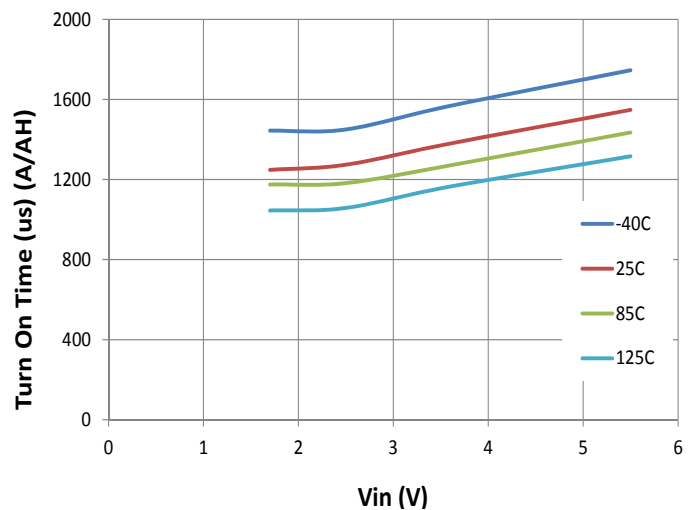
**Fall Time at 10 Ohm Load**



**Rise Time at 10 Ohm Load**



**ON Time at 10 Ohm Load**

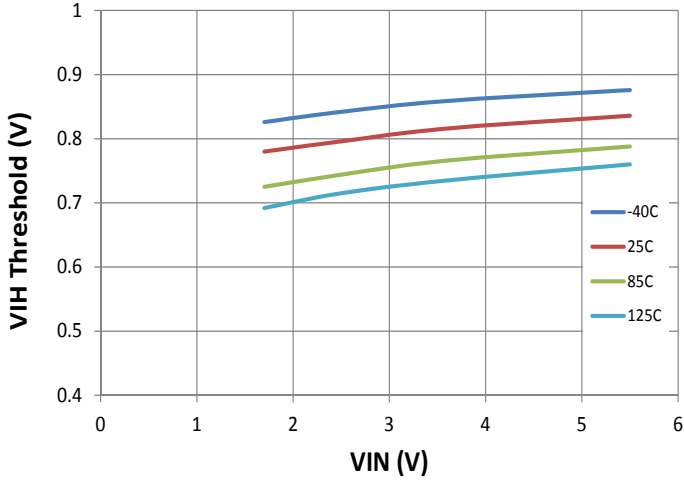




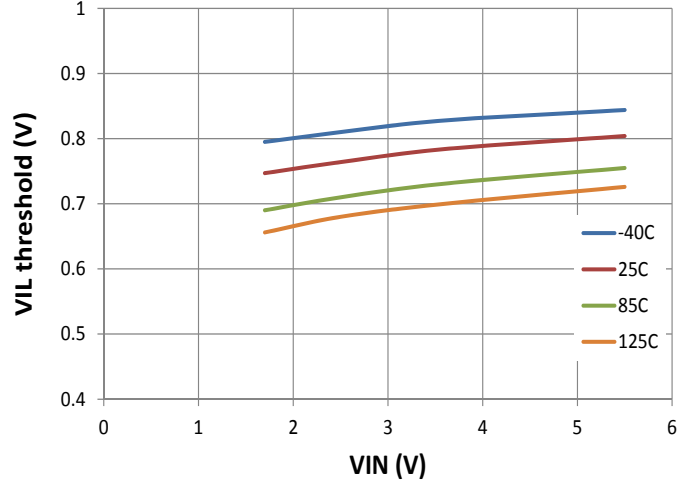
## Typical Characteristics:

Characteristics in this section are based upon using SC33001A, AH evaluation board ( $C_{IN} = 22\mu F + 1\mu F$ ,  $C_{OUT} = 22\mu F + 1\mu F$ ).

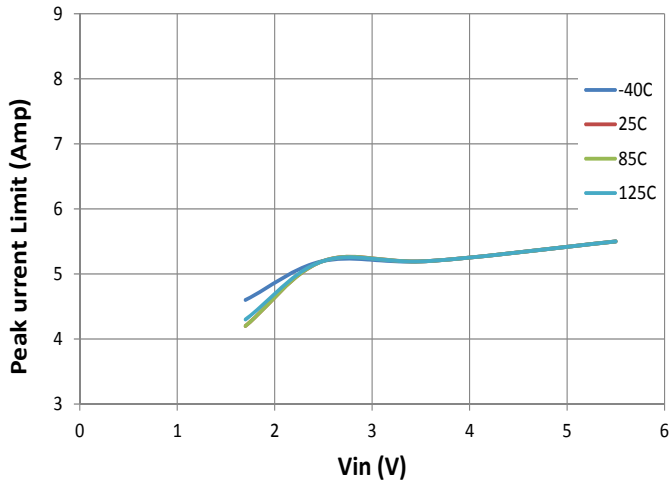
### EN Rising Threshold



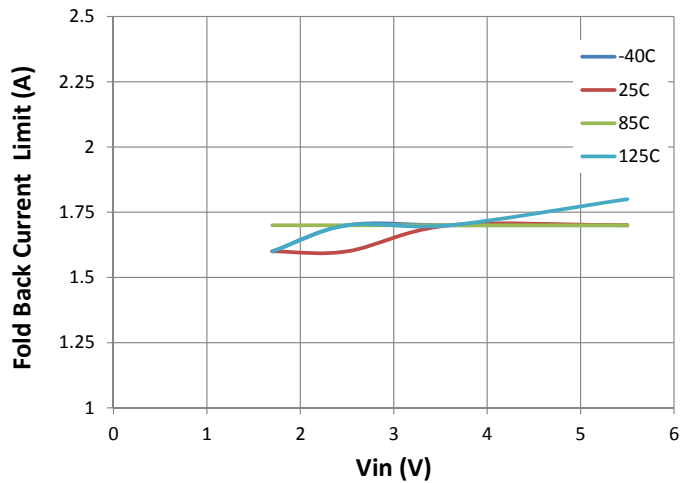
### EN Falling Threshold



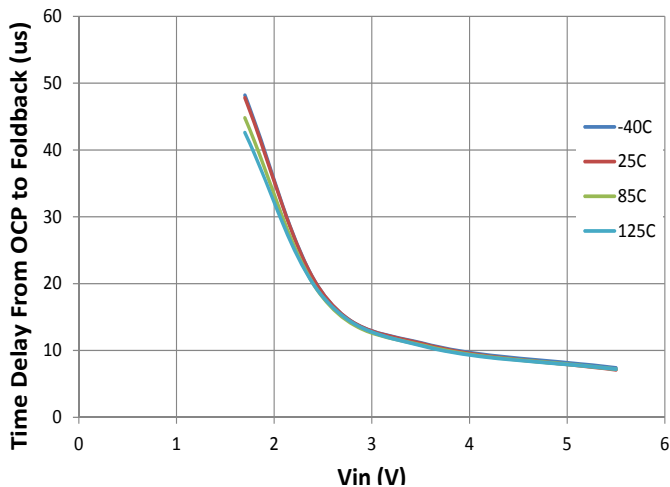
### Short Circuit OCP Limit



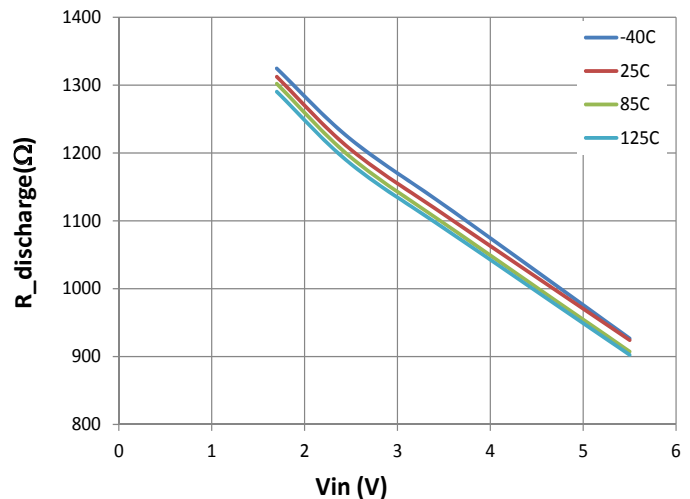
### FOLD Back Current Limit



### Delay Time from OCP to Foldback



### Vout Discharge Resistance After Off, Non-H Device



## Applications Information

### 3A Load Switch

The SC33001A/AH are a family of an ultra-low  $R_{ds(on)}$  load switch optimized for use in battery powered applications. This family of device supports up to 3A continuous output current. Sophisticated integrated circuitry maximizes  $V_{gs}$  of the power NMOS to minimize  $R_{ds(on)}$  resistance over a wide range of operating conditions.

### Input Capacitor

The primary purpose of input capacitance for SC33001A/AH is to hold the voltage at  $V_{in}$  pins constant when the switch is transition between open and closed. When the switch is closing, the input capacitor prevents the voltage at  $V_{in}$  from dropping. When the switch is opening, the input capacitor limits voltage spikes.

Ceramic capacitors should be derated for temperature and bias. As a result, applications up to 3.6V should use capacitors rated 6.3V. Applications up to 5.5V should use capacitors rated 10V.

### Output Capacitor

The purpose of output capacitance is to absorb transients on the output.  $C_{in}$  should be selected to be higher in value than  $C_{out}$ . This is because the integrated body diode of the SC33001A/AH does not have reverse voltage protection. If the input supply is removed while the switch is closed,  $C_{in}$  higher than  $C_{out}$  helps prevent reverse bias of the integrated body diode.

Use the same voltage rating criteria for the output capacitor as the input capacitor as described in above section.

### Output Voltage Pull-down

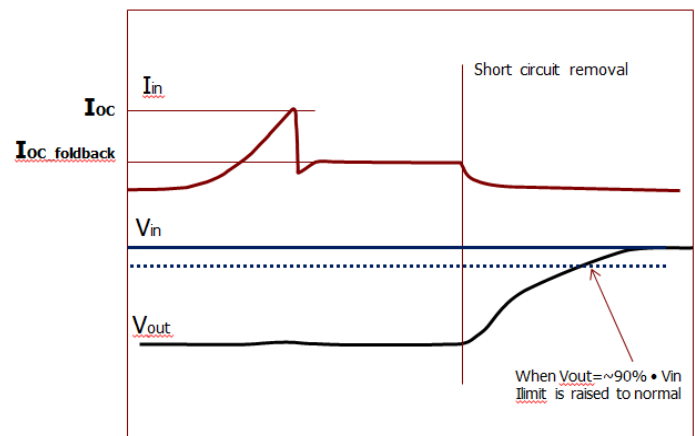
The SC33001A has an internal pull-down resistor. When the SC33001A is disabled, the output pull-down resistor discharges the output capacitor through 1.1 k $\Omega$ .

### Protection

The SC33001A/AH have current limit protection (OCP). Current limit is quickly invoked when  $V_{in}$  current exceeds current limit threshold ( $I_{LIM}$ ). The current limit is then folded back to current limit foldback ( $I_{LIM\_FOLD}$ ). This fold back limit will be held for about 100 $\mu$ s before it can be released back to it's full value current limit ( $I_{LIM}$ ). The decision to raise current limit back to it's full value is based on the voltage at  $V_{out}$ . If the voltage on  $V_{out}$  is approxi-

mately 90% of  $V_{IN}$  ( $V_{Rth\_ILIM\_TR}$ ) and the part has been in foldback for the minimum time, then current limit is returned to it's full value ( $I_{LIM}$ ).

Startup into a short circuit behavior is illustrated in Figure 1. As the switch current increases beyond the over-current protection threshold, the device will go into foldback current limit. The current is regulated to the reduced foldback current limit level. Upon the short circuit removal, as the load current is smaller than the foldback current limit, the output voltage will rise. When the output voltage rises to  $\sim 90\%$  of  $V_{IN}$ , current limit will return to the normal over-current protection level and resume normal operation.



**Figure 1 — Startng into Short Circuit and Recovery from Short Circuit Removal Behavior**

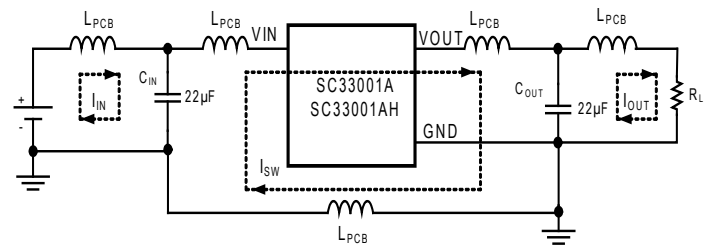
SC33001A/AH have over-temperature protection (OTP). If the junction temperature rises to a typical value of 160 degree ( $T_{th}$ ), the device will shutdown. Once the temperature drops by about 38 degree ( $T_{hys}$ ), the device will restart automatically. In case the output is shorted and OTP has been triggered, the restart or hiccup mode operation current limit will be held at fold back current limit ( $I_{LIM\_FOLD}$ ), refer to the waveform in page 7.

With a permanent short circuit on the output, the device junction temperature will be “regulated” by the OTP circuits. The temperature will cychel between  $T_{th}$  and ( $T_{th}-T_{hys}$ ) with alternate operation of current limit at  $I_{LIM\_FOLD}$  and shutdown modes.

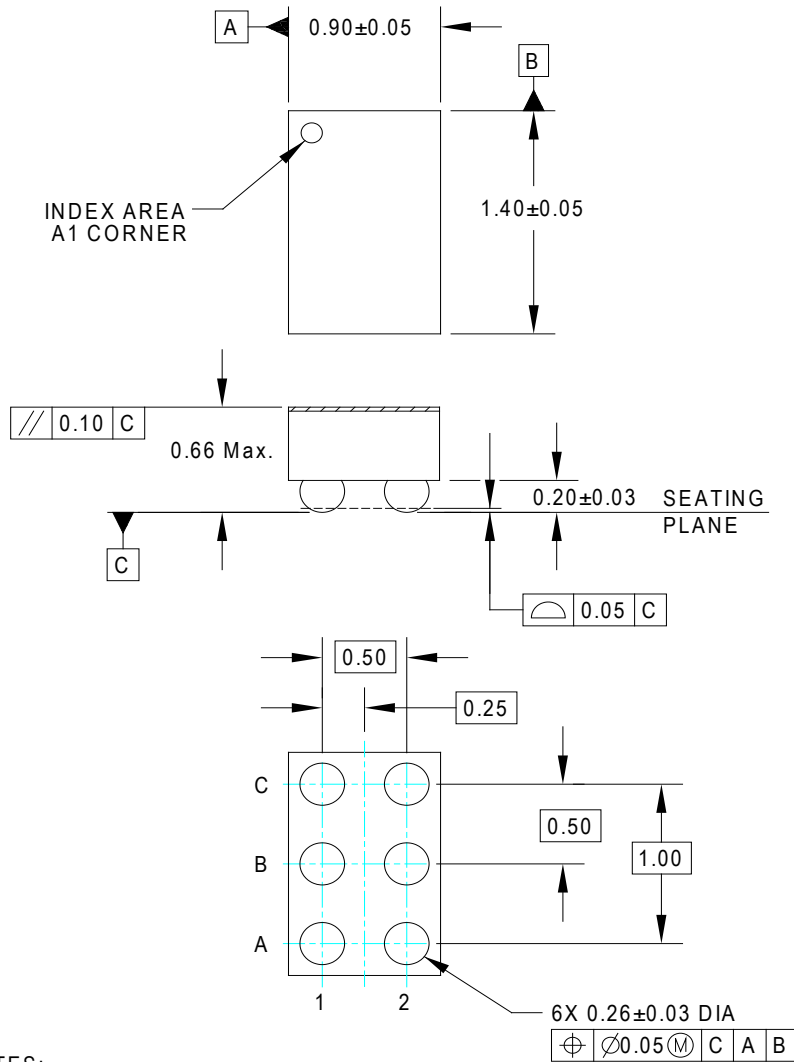
## Applications Information

### PCB Layout

Figure 2 shows the typical application circuit with PCB inductance on the circuit board. An important objective of the layout is to minimize the PCB inductance by reducing the length and increasing the width of the traces. The input and output capacitors need to be placed close to the SC33001A/AH. The PCB inductance only effects the performance during the turn-on, turn-off and load transients. Figure 2 shows three current loops during the opening or closing of the switch. The magnitude of the voltage ringing at VIN or VOUT pin depends on the value of PCB inductance and placement of the capacitors. It is important to keep the voltage below the maximum rating of the SC33001A/AH.

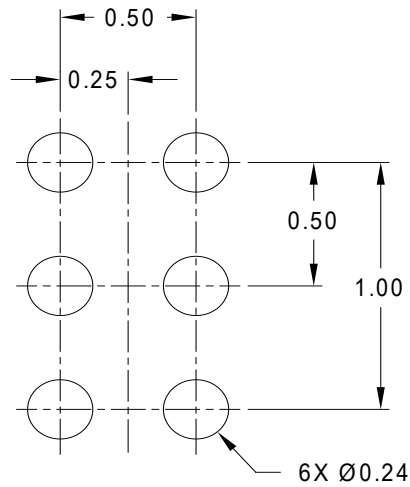


**Figure 2 — Parasitic Inductance Loops on a PCB Board, Inductance Needs to be Minimized in Layout by Placing Input and Output Capacitor Close to IC.**

**Outline Drawing — CSP 0.9mm x 1.4mm, 6-Bump**

**NOTES:**

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS

## Land Pattern Drawing — CSP 0.9mm x 1.4mm, 6-Bump



## NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS
2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.

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## Contact Information

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|          |  |                |  |
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| Taiwan   | Tel: 886-2-2748-3380<br>Fax: 886-2-2748-3390 | Switzerland    | Tel: 41-32-729-4000<br>Fax: 41-32-729-4001         |
| Korea    | Tel: 82-2-527-4377<br>Fax: 82-2-527-4376     | United Kingdom | Tel: 44-1794-527-600<br>Fax: 44-1794-527-601       |
| Shanghai | Tel: 86-21-6391-0830<br>Fax: 86-21-6391-0831 | France         | Tel: 33-(0)169-28-22-00<br>Fax: 33-(0)169-28-12-98 |
| Japan    | Tel: 81-3-5719-7560<br>Fax: 81-3-5719-7561   | Germany        | Tel: 49-(0)8161-140-123<br>Fax: 49-(0)8161-140-124 |

## Данный компонент на территории Российской Федерации

### Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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